



Final Product Change Notification

202004018F01

Issue Date: 06-May-2020

Effective Date: 04-Aug-2020

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QUALITY

Management Summary

Second sourcing waferfab production for TEA19162T/2, TEA19162T/3 and TEA19162HT/2 in ICN8.

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input checked="" type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

Change in Order to Guarantee the Supply to Customers in the Current Time, Second Source Waferfab ICN8 for TEA19162*

Description of Change

Change in order to guarantee the supply to customers in the current time, internal second source waferfab for TEA19162T/2, TEA19162T/3 and TEA19162HT/2 in ICN8 next to Vanguard (VIS).

Reason for Change

To guarantee the supply to customers a second source (ICN-8) will be released for TEA19162T/2, TEA19162T/3 and TEA19162HT/2.

Identification of Affected Products

Top side marking

Top side marking for the first and second line will remain the same for all 3 types:

1: TEA19162T/2, TEA19162T/3: EA19162

1: TEA19162HT/2: A19162H

2: DBID & ASID

Top side marking will change for all 3 types on the third line from: rXDyww2 (VIS) to

3: TEA19162T/2 to TXDyww2 (ICN8)

3: TEA19162T/3 to TXDyww3 (ICN8)

3: TEA19162HT/2 to TXDyww2 (ICN8)

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 03-Aug-2020

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 05-Jun-2020.

n.a.

Remarks

n.a.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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Affected Part Number

TEA19162T/2J